

November 2013

# **3-terminal Filters**

For signal line

# MEM series

2012[0805 inch]*
2012[0805 inch]
2012[0805 inch]
2012[0805 inch]
1608[0603 inch]

\* Dimensions Code JIS[EIA]

Before using these products, be sure to request the delivery specifications.

## SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

\Lambda REM	INDERS
The storage period is less than 12 months. Be sure to follow the s or less).	torage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH
If the storage period elapses, the soldering of the terminal electron	les may deteriorate.
$\bigcirc$ Do not use or store in locations where there are conditions such as	s gas corrosion (salt, acid, alkali, etc.).
<ul> <li>Before soldering, be sure to preheat components.</li> <li>The preheating temperature should be set so that the temperature does not exceed 150°C.</li> </ul>	difference between the solder temperature and chip temperature
<ul> <li>Soldering corrections after mounting should be within the range of If overheated, a short circuit, performance deterioration, or lifespar</li> </ul>	•
When embedding a printed circuit board where a chip is mounted the overall distortion of the printed circuit board and partial distortion	•
<ul> <li>Self heating (temperature increase) occurs when the power is turn design.</li> </ul>	ed ON, so the tolerance should be sufficient for the set thermal
Carefully lay out the coil for the circuit board design of the non-may A malfunction may occur due to magnetic interference.	gnetic shield type.
$\bigcirc$ Use a wrist band to discharge static electricity in your body through	n the grounding wire.
O Do not expose the products to magnets or magnetic fields.	
$\bigcirc$ Do not use for a purpose outside of the contents regulated in the d	elivery specifications.
<ul> <li>The products listed on this catalog are intended for use in general equipment, home appliances, amusement equipment, computer equipment, industrial robots) under a normal operation and use con The products are not designed or warranted to meet the requirement quality require a more stringent level of safety or reliability, or whose society, person or property.</li> <li>If you intend to use the products in the applications listed below or set forth in the each catalog, please contact us.</li> </ul>	quipment, personal equipment, office equipment, measurement ndition. ents of the applications listed below, whose performance and/or
<ol> <li>(1) Aerospace/Aviation equipment</li> <li>(2) Transportation equipment (cars, electric trains, ships, etc.)</li> <li>(3) Medical equipment</li> <li>(4) Power-generation control equipment</li> <li>(5) Atomic energy-related equipment</li> <li>(6) Seabed equipment</li> <li>(7) Transportation control equipment</li> </ol>	<ul> <li>(8) Public information-processing equipment</li> <li>(9) Military equipment</li> <li>(10) Electric heating apparatus, burning equipment</li> <li>(11) Disaster prevention/crime prevention equipment</li> <li>(12) Safety equipment</li> <li>(13) Other applications that are not considered general-purpose applications</li> </ul>
When designing your equipment even for general-purpose application protection circuit/device or providing backup circuits in your equipmer	

## **3-terminal Filters**

For signal line

Product compatible with RoHS directive Halogen-free Compatible with lead-free solders

# **Overview of the MEM Series**

### FEATURES

- O Multilayer chip EMC filter.
- O Monolithic structure makes it highly reliable.
- O Closed magnetic circuit structure makes it possible to achieve high-density mounting without crosstalk.
- O Has sharp attenuation characteristics with excellent EMC suppression.
- O Wide range of products compatible with passing frequencies and attenuating frequencies.

### **MEM2012S**

### MEM2012V

○ T-type circuit is used.

### $\bigcirc$ Sharp attenuation characteristics.

MEM2012SC

○ T-type circuit is used.

O Compatible with 1A current.

### MEM2012F

 $\bigcirc \pi$  type circuit is used.

 $\bigcirc$  Double  $\pi$  type circuit is used.

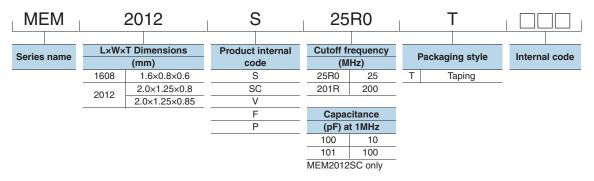
### MEM1608P

π type circuit is used.
 Compact with a low profile design.

### APPLICATION

Noise removal from signal lines of data terminals, digital cameras, computers, game machines, flat TVs, etc.

### PART NUMBER CONSTRUCTION



### OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range		
Туре	Operating temperature	Storage temperature*	Package quantity	Individual weight
	(° <b>C</b> )	(°C)	(pieces/reel)	(mg)
MEM2012S	-40 to +85	-40 to +85	4,000	8
MEM2012SC	-40 to +85	-40 to +85	4,000	8
MEM2012V	-40 to +85	-40 to +85	4,000	8
MEM2012F	-40 to +85	-40 to +85	4,000	8
MEM1608P	-40 to +85	-40 to +85	4,000	3.5

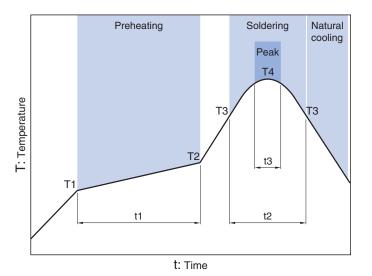
\* The Storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://www.tdk.co.jp/rohs/
 Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

<sup>•</sup> All specifications are subject to change without notice.

## **Overview of the MEM Series**

### RECOMMENDED REFLOW PROFILE



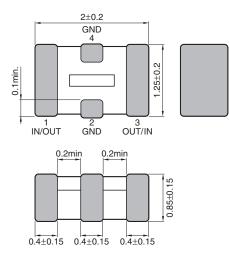
Preheatin	ıg		Soldering	Ĵ	Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	Т3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s max.

<sup>•</sup> All specifications are subject to change without notice.

## EMC Components

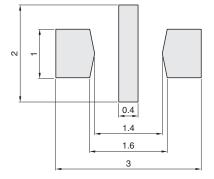
# MEM series MEM2012S Type



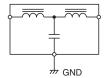


Dimensions in mm

### RECOMMENDED LAND PATTERN



### **CIRCUIT DIAGRAM**



Dimensions in mm

• All specifications are subject to change without notice.

## MEM series MEM2012S Type

### ELECTRICAL CHARACTERISTICS

### **CHARACTERISTICS SPECIFICATION TABLE**

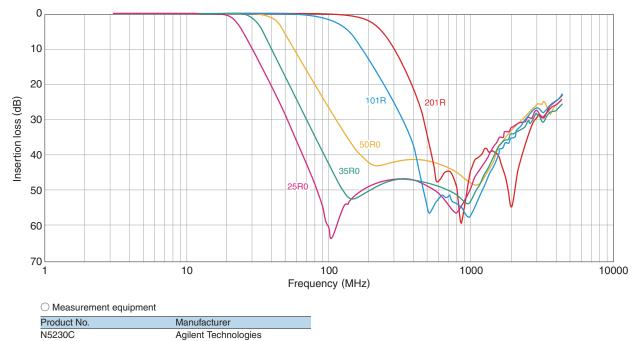
Cutoff frequency (MHz)	Insertion loss (dB)min.	Rated voltage (V)max.	Rated current (mA)max.	Part No.
25	30[70MHz to 2GHz]	10	100	MEM2012S25R0T
35	30[90MHz to 2GHz]	10	100	MEM2012S35R0T
50	30[200MHz to 2GHz]	10	100	MEM2012S50R0T
100	30[400MHz to 2GHz]	10	250	MEM2012S101RT
200	30[530MHz to 2GHz]	10	250	MEM2012S201RT

#### ○ Measurement equipment

• • • • • • • • • • • • • • • • • • • •		
Measurement item	Product No.	Manufacturer
Frequency characteristics	N5230C	Agilent Technologies

\* Equivalent measurement equipment may be used.

### □ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



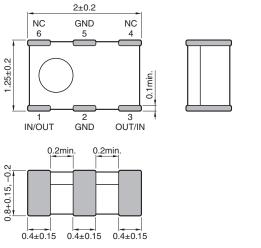
\* Equivalent measurement equipment may be used.

<sup>•</sup> All specifications are subject to change without notice.

### EMC Components

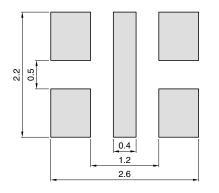
# MEM series MEM2012SC Type



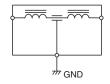


Dimensions in mm

### RECOMMENDED LAND PATTERN



### **CIRCUIT DIAGRAM**



Dimensions in mm

## MEM series MEM2012SC Type

### ELECTRICAL CHARACTERISTICS

### CHARACTERISTICS SPECIFICATION TABLE

Capacitance* (pF)	Tolerance (%)	Rated voltage (V)max.	Rated current (A)max.	DC resistance (Ω)max. [Terminal No.1 to 3]	Part No.
10	±30	12	1	0.15	MEM2012SC100T
22	±30	12	1	0.15	MEM2012SC220T
47	±30	12	1	0.15	MEM2012SC470T
100	±30	12	1	0.15	MEM2012SC101T
150	±30	12	1	0.15	MEM2012SC151T

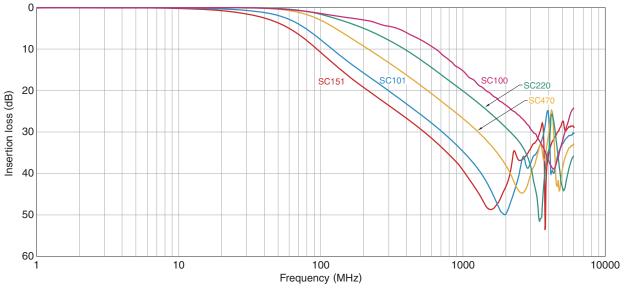
\* Measuring frequency: 1(MHz), measuring voltage: 1(V)

### $\bigcirc$ Measurement equipment

Measurement item	Product No.	Manufacturer
Capacitance	4294A	Agilent Technologies
Frequency characteristics	N5230C	Agilent Technologies
riequency characteristics	1102000	Aglient reenhologies

\* Equivalent measurement equipment may be used.

### □ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



 $\bigcirc$  Measurement equipment

Product No. Manufacturer

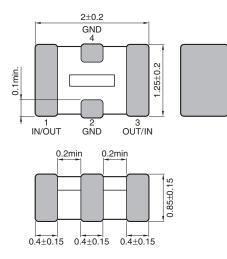
N5230C Agilent Technologies

\* Equivalent measurement equipment may be used.

<sup>•</sup> All specifications are subject to change without notice.

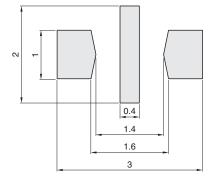
# MEM series MEM2012V Type

### SHAPE & DIMENSIONS

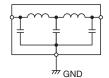


Dimensions in mm

### RECOMMENDED LAND PATTERN



### **CIRCUIT DIAGRAM**



Dimensions in mm



<sup>•</sup> All specifications are subject to change without notice.

## MEM series MEM2012V Type

### ELECTRICAL CHARACTERISTICS

### **CHARACTERISTICS SPECIFICATION TABLE**

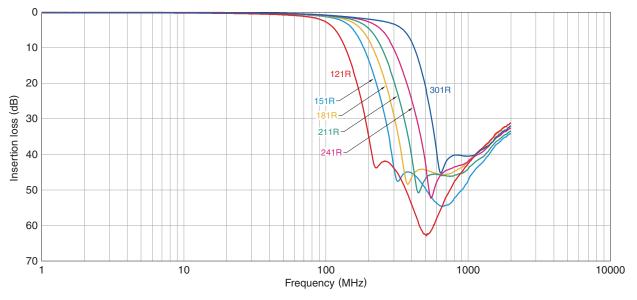
Cutoff frequency (MHz)	Insertion loss (dB)min.	Rated voltage (V)max.	Rated current (mA)max.	Part No.
120	20 [200MHz to 2GHz]	10	100	MEM2012V121RT
150	20 [250MHz to 2GHz]	10	100	MEM2012V151RT
180	20 [300MHz to 2GHz]	10	100	MEM2012V181RT
210	20 [350MHz to 2GHz]	10	100	MEM2012V211RT
240	20 [450MHz to 2GHz]	10	100	MEM2012V241RT
300	20 [550MHz to 2GHz]	10	100	MEM2012V301RT

O Measurement equipment

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Measurement item	Product No.	Manufacturer
Frequency characteristics	N5230C	Agilent Technologies

\* Equivalent measurement equipment may be used.

### □ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



○ Measurement equipment

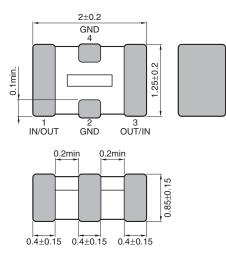
Product No. Manufacturer N5230C Agilent Technologies

\* Equivalent measurement equipment may be used.

• All specifications are subject to change without notice.

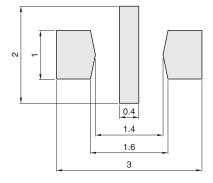
# MEM series MEM2012F Type



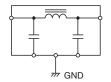


Dimensions in mm

### RECOMMENDED LAND PATTERN



### CIRCUIT DIAGRAM



Dimensions in mm



<sup>•</sup> All specifications are subject to change without notice.

## MEM series MEM2012F Type

### ELECTRICAL CHARACTERISTICS

### **CHARACTERISTICS SPECIFICATION TABLE**

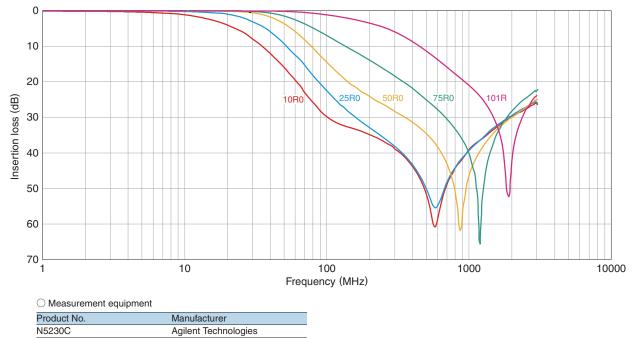
Cutoff frequency (MHz)	Insertion loss (dB)min.	Rated voltage (V)max.	Rated current (mA)max.	Part No.
10	20 [200MHz to 2GHz]	12	200	MEM2012F10R0T
25	20 [300MHz to 2GHz]	12	200	MEM2012F25R0T
50	20 [400MHz to 2GHz]	12	200	MEM2012F50R0T
75	20 [700MHz to 2GHz]	12	200	MEM2012F75R0T
100	20 [1.5GHz to 2GHz]	12	200	MEM2012F101RT

#### ○ Measurement equipment

• • • • • • • • • • • • • • • • • • • •		
Measurement item	Product No.	Manufacturer
Frequency characteristics	N5230C	Agilent Technologies

\* Equivalent measurement equipment may be used.

### □ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS

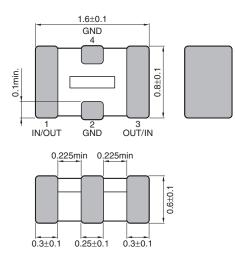


\* Equivalent measurement equipment may be used.

• All specifications are subject to change without notice.

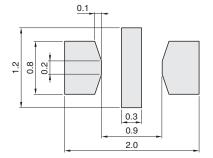
# MEM series MEM1608P Type

### SHAPE & DIMENSIONS

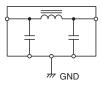


Dimensions in mm

### RECOMMENDED LAND PATTERN



### **CIRCUIT DIAGRAM**



Dimensions in mm



<sup>•</sup> All specifications are subject to change without notice.

## MEM series MEM1608P Type

### ELECTRICAL CHARACTERISTICS

### **CHARACTERISTICS SPECIFICATION TABLE**

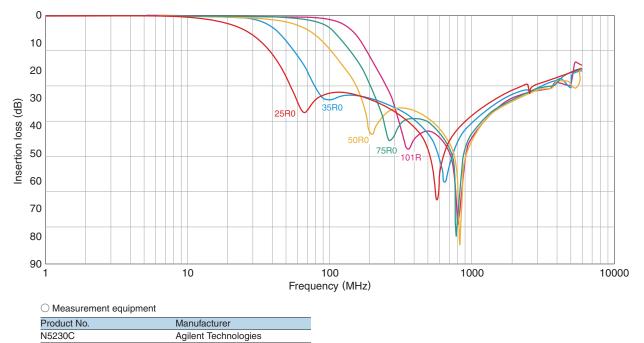
Cutoff frequency (MHz)	Insertion loss (dB)min.	Rated voltage (V)max.	Rated current (mA)max.	Part No.
25	20[70MHz to 2GHz]	10	100	MEM1608P25R0T
35	20[90MHz to 2GHz]	10	100	MEM1608P35R0T
50	20[200MHz to 2GHz]	10	100	MEM1608P50R0T
75	20[300MHz to 2GHz]	10	100	MEM1608P75R0T
100	20[400MHz to 2GHz]	10	100	MEM1608P101RT

#### ○ Measurement equipment

• · · · · · · · · · · · · · · · · · · ·		
Measurement item	Product No.	Manufacturer
Frequency characteristics	N5230C	Agilent Technologies

\* Equivalent measurement equipment may be used.

### □ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



\* Equivalent measurement equipment may be used.

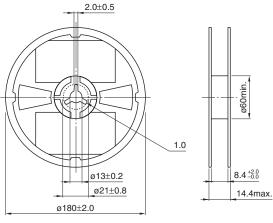
<sup>•</sup> All specifications are subject to change without notice.

#### Components EMC

## MEM series

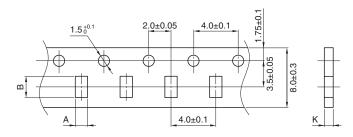
# **Packaging style**

### **REEL DIMENSIONS**

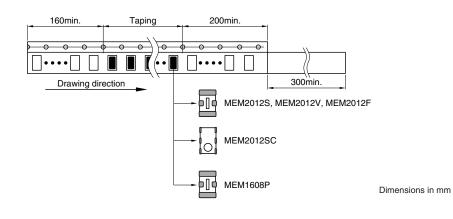


Dimensions in mm

### **TAPE DIMENSIONS**



	Dimensions in mm		
Туре	A	В	K
MEM2012S	1.55±0.20	2.30±0.20	1.10max.
MEM2012SC	1.55±0.20	2.30±0.20	1.10max.
MEM2012V	1.55±0.20	2.30±0.20	1.10max.
MEM2012F	1.55±0.20	2.30±0.20	1.10max.
MEM1608P	1.10±0.20	1.90±0.20	0.90max.



• All specifications are subject to change without notice.